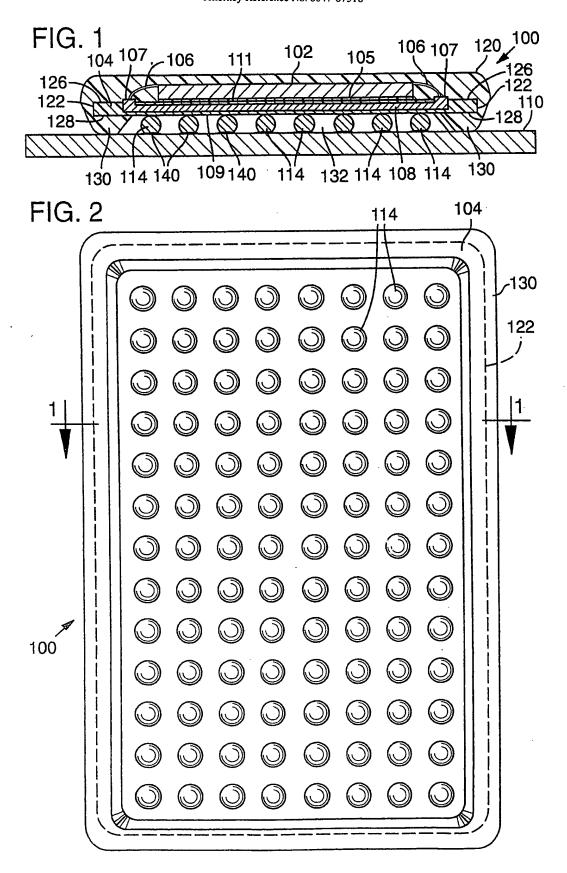


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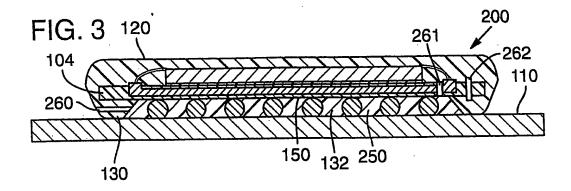


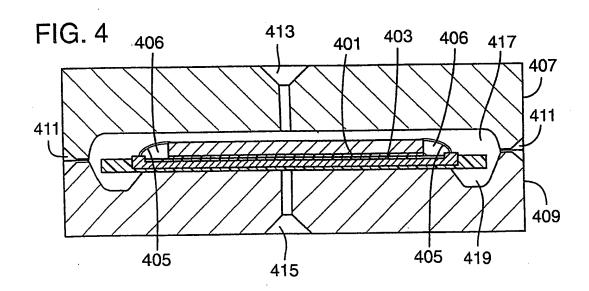


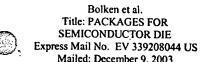


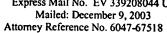
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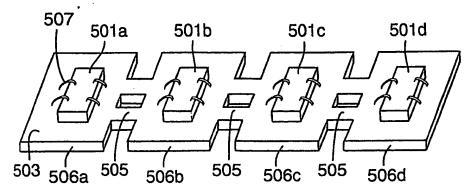
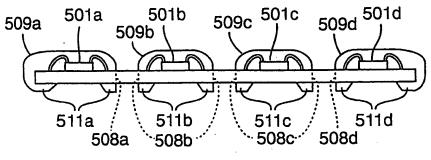


FIG. 5B



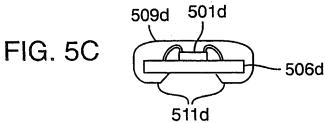


FIG. 5D

